2SD2136

Silicon NPN triple diffusion planar type

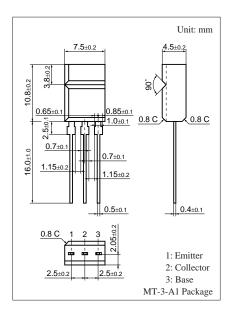
For power amplification Complementary to 2SB1416

■ Features

- \bullet High forward current transfer ratio h_{FE} which has satisfactory linearity.
- \bullet Low collector-emitter saturation voltage $V_{\text{CE}(\text{sat})}$
- Allowing supply with the radial taping

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|------------------|-------------|------|
| Collector-base voltage (Emitter open) | V _{CBO} | 60 | V |
| Collector-emitter voltage (Base open) | V _{CEO} | 60 | V |
| Emitter-base voltage (Collector open) | V _{EBO} | 6 | V |
| Collector current | I_C | 3 | A |
| Peak collector current | I_{CP} | 5 | A |
| Collector power dissipation | P_{C} | 1.5 | W |
| Junction temperature | T_j | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |



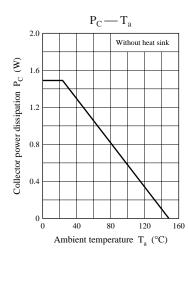
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

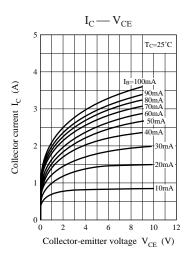
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|---|----------------------|---|-----|-----|-----|------|
| Collector-emitter voltage (Base open) | V _{CEO} | $I_C = 30 \text{ mA}, I_B = 0$ | 60 | | | V |
| Base-emitter voltage *1 | V_{BE} | $V_{CE} = 4 \text{ V}, I_{C} = 3 \text{ A}$ | | | 1.8 | V |
| Collector-emitter cutoff current (Emitter-base short) | I _{CES} | $V_{CE} = 60 \text{ V}, V_{BE} = 0$ | | | 200 | μΑ |
| Collector-emitter cutoff current (Base open) | I_{CEO} | $V_{CE} = 30 \text{ V}, I_{B} = 0$ | | | 300 | μΑ |
| Emitter-base cutoff current (Collector open) | I_{EBO} | $V_{EB} = 6 \text{ V}, I_{C} = 0$ | | | 1 | mA |
| Forward current transfer ratio | h _{FE1} *2 | $V_{CE} = 4 \text{ V}, I_{C} = 1 \text{ A}$ | 40 | | 250 | _ |
| | h _{FE2} *1 | $V_{CE} = 4 \text{ V}, I_{C} = 3 \text{ A}$ | 10 | | | |
| Collector-emitter saturation voltage *1 | V _{CE(sat)} | $I_C = 3 \text{ A}, I_B = 0.375 \text{ A}$ | | | 1.2 | V |
| Transition frequency | f_T | $V_{CE} = 5 \text{ V}, I_{E} = -0.1 \text{ A}, f = 200 \text{ MHz}$ | | 220 | | MHz |
| Turn-on time | t _{on} | $I_C = 1 A$, $I_{B1} = 0.1 A$, $I_{B2} = -0.1 A$ | | 0.5 | | μs |
| Storage time | t _{stg} | | | 2.5 | | μs |
| Fall time | t _f | | | 0.4 | | μs |

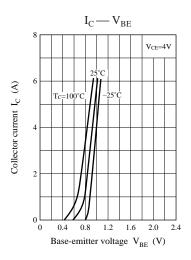
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

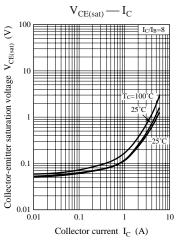
- 2. *1: Pulse measurement
 - *2: Rank classification

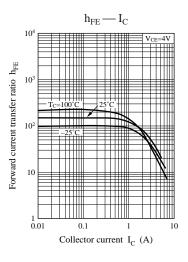
| Rank | Р | Q | R |
|-----------|----------|-----------|------------|
| h_{FE1} | 40 to 90 | 70 to 150 | 120 to 250 |

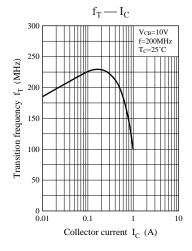


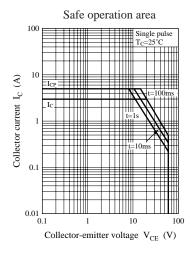


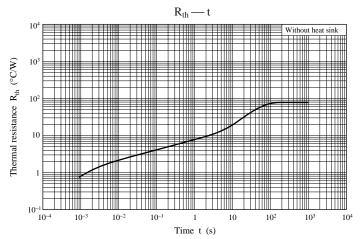












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